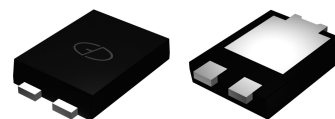


Features

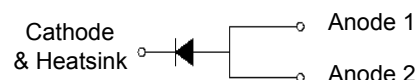
- Low profile - typical height 1.1 mm
- Low forward voltage drop
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- High temperature soldering guaranteed: 260°C/10 seconds
- Halogen-free according to IEC 61249-2-21 definition



Package:
eSGC (TO-277)

Applications

For low voltage high frequency inverters, DC/DC converters and polarity protection applications.



Schematic Diagram

Maximum Ratings (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	100	V
Maximum RMS Voltage	V _{RMS}	70	V
Maximum DC Blocking Voltage	V _{DC}	100	V
Maximum Average Forward Rectified Current	I _{F(AV)}	5.0	A
Peak Forward Surge Current (8.3ms single half sine-wave superimposed on rated load)	I _{FSM}	175	A
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (T_A = 25°C unless otherwise noted)

Parameter	Test Conditions		Symbol	Typ.	Max.	Unit
Maximum Instantaneous Forward Voltage	I _F =1A	T _A =25°C	V _F	0.51	0.55	V
	I _F =2A			0.58	0.65	
	I _F =5A			0.70	0.75	
	I _F =1A	T _A =85°C		0.45	0.50	
	I _F =2A			0.53	0.60	
	I _F =5A			0.62	0.68	
	I _F =1A	T _A =125°C		0.40	0.45	
	I _F =2A			0.47	0.55	
	I _F =5A			0.56	0.62	
Maximum DC Reverse Current at Rated DC Blocking Voltage	Rated V _R	T _A =25°C	I _R	0.05	0.1	mA
		T _A =85°C		0.2	1	
		T _A =125°C		1	20	
Junction Capacitance	4.0 V, 1 MHz		C _J	265		pF
Typical Thermal Resistance	Juntion to Lead		R _{θJL}	60		°C/W

Ratings and Characteristics Curves ($T_A = 25^\circ\text{C}$ unless otherwise noted)

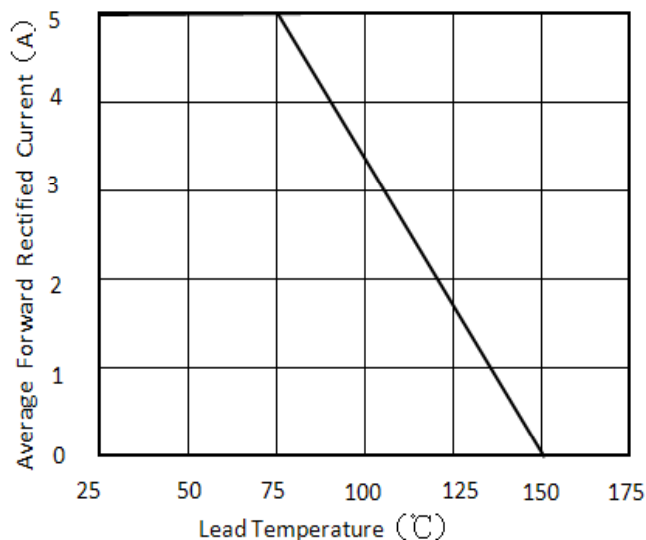


Figure 1. Forward Current Derating Curve

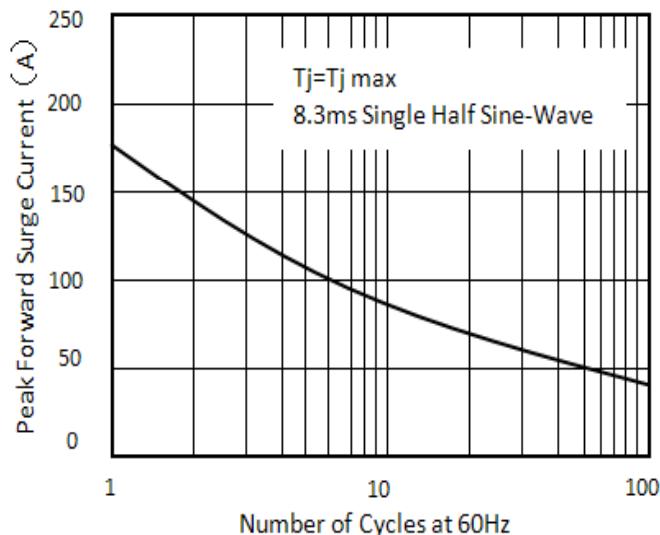


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

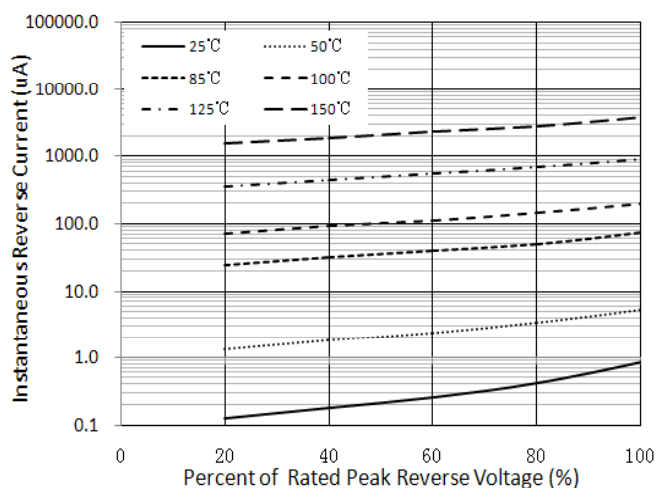


Figure 3. Typical Reverse Characteristics

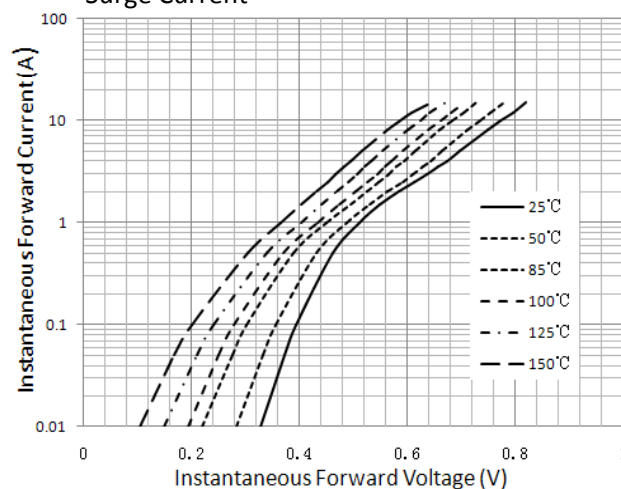


Figure 4. Typical Instantaneous Forward Characteristics

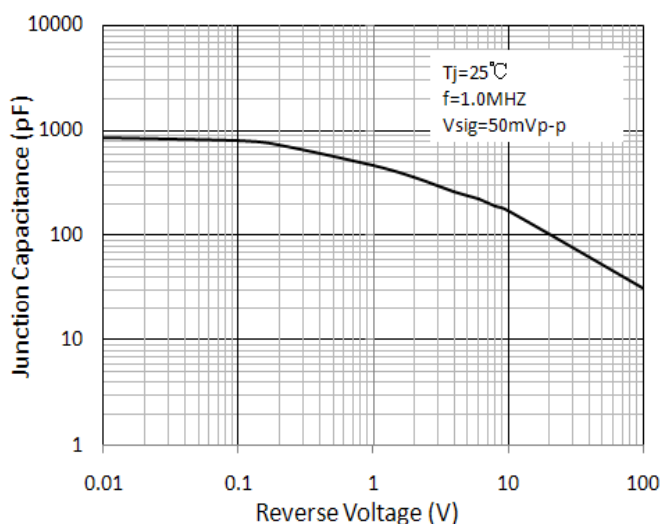
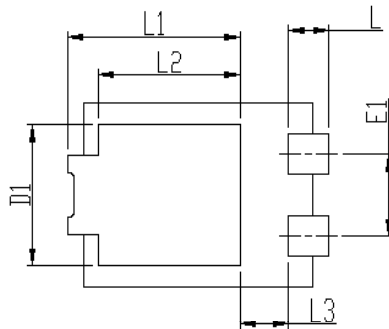
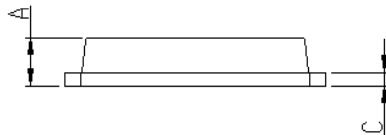
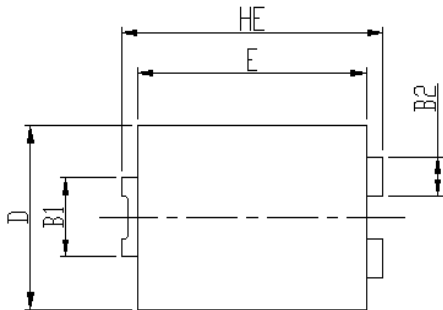


Figure 5. Typical Junction Capacitance

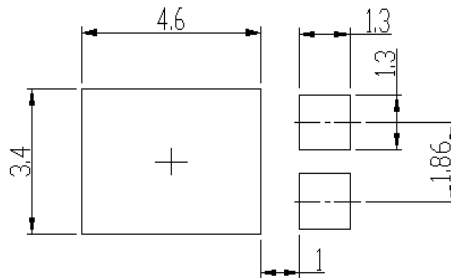
Package Outline Dimensions

eSGC (TO-277)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
HE	6.4	6.6	0.252	0.260
E	5.6	5.8	0.220	0.228
D	4.1	4.3	0.161	0.169
B1	1.7	1.9	0.067	0.075
B2	0.8	1	0.031	0.039
A	1.05	1.2	0.041	0.047
C	0.3	0.4	0.012	0.016
L	0.85	1.1	0.033	0.043
L1	4.2	4.4	0.165	0.173
L2	3.52	Typ.	0.139	Typ.
L3	1.1	1.4	0.043	0.055
D1	3	3.3	0.118	0.130
E1	1.86	Typ.	0.073	Typ.

Soldering footprint



Packing Information

Packing quantities

5000 pcs/Reel, 12 mm Tape, 13" Reel

Tape & Reel Specification

